

20-140

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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(See note C)

Full name of sole or first inventor (given name, family name) Ryo MATSUHASHI *rw*
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Full name of ninth inventor (given name, family name) Kunihiko DAIDO 9a
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Full name of tenth inventor (given name, family name) Yoshinori SHIMOMURA 10a
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Full name of eleventh inventor (given name, family name) Takayasu NAKAHAMA 11a
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(See note C) Full name of sole or first inventor (given name, family name) 100 **Ryo MATSUHASHI**
Inventor's signature Ryo Matsuhashi Date April 21, 2005
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Post Office Address c/o Nippon Steel Corporation, Technical Development Bureau,
20-1, Shintomi, Futtsu-shi, Chiba 293-0011 Japan

Full name of second inventor (given name, family name) 20 **Kazuhiro SUETSUGU**
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Full name of third inventor (given name, family name) 300 **Hideyuki MIYAGAWA**
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Full name of fourth inventor (given name, family name) 400 **Toshio KITA**
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Full name of fifth inventor (given name, family name) 500 **Kyota SOGABE**
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DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

PIPE COUPLING

the specification of which is attached hereto unless the following is checked

☒ was filed on 09/07/2003 as United States Application Number or PCT International

Application Number PCT/JP03/08698 and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) – (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed.

(List prior foreign applications. See note A)

Priority Claimed

Pat. 2002-199919
(Number)

Japan
(Country)

09/07/2002
(Day/Month/Year Filed)

☒ Yes ☐ No

(Number)

(Country)

(Day/Month/Year Filed)

☐ Yes ☐ No

(Number)

(Country)

(Day/Month/Year Filed)

☐ Yes ☐ No

(Number)

(Country)

(Day/Month/Year Filed)

☐ Yes ☐ No

(See note B)

☐ See attached list for additional prior foreign applications

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(List prior U.S. Applications)

Status

(Application Serial No.)

(Filing Date)

☐ Patented ☐ Pending ☐ Abandoned

(Application Serial No.)

(Filing Date)

☐ Patented ☐ Pending ☐ Abandoned

(Application Serial No.)

(Filing Date)

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